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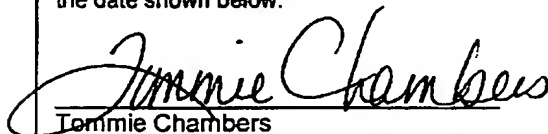
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NAME OF INVENTOR(S): Barnett		RECEIPT DATE & SERIAL NO.: Serial No.: 10/696,827 Filing Date: 10/30/2003	
TITLE OF INVENTION: CIRCUIT AND METHOD TO COMPENSATE FOR RMR VARIATIONS AND FOR SHUNT RESISTANCE ACROSS RMR IN AN OPEN LOOP CURRENT BIAS ARCHITECTURE			
TI FILE NO.: TI-36061	DEPOSIT ACCT. NO.: 20-0668		
FAXED: 3-18-05 DUE: 03/04/2005 ATTY/SECY: wds/tlc			

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Barnett

Docket No: TI-36061

Serial No: 10/696,827

Examiner: Wells, Kenneth B.

Filed: 10/30/2003

Art Unit: 2816

For: CIRCUIT AND METHOD TO COMPENSATE FOR RMR VARIATIONS
AND FOR SHUNT RESISTANCE ACROSS RMR IN AN OPEN LOOP CURRENT BIAS
ARCHITECTURE

AMENDMENT PURSUANT TO 37 CFR 1.116

Assistant Commissioner for Patents
Washington, DC 20231

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Tommie Chambers
Tommie Chambers 3-18-05

Dear Sir:

Responsive to the Office Action mailed January 4, 2005, in connection with the
above identified application, Applicant respectfully submits the following amendments
and remarks.

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